

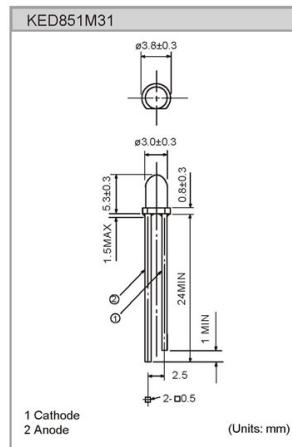
Plastic Mold Infrared LEDs KED851M31

Features

- Transparent epoxy mold
- High power:22mW
- High speed response:25ns rise time
- Direct modulation

Applications

- Available for wireless digital transmission
- Optical switches
- Optical encoders
- Optical instruments
- Automatic control apparatus



■ Specifications

● Absolute Maximum Ratings

Parameter	Symbol	Value	Unit	Conditions
Forward current	I _F	100	mA	
Peak forward current	I _{FP}	1	A	Puls width=100μs, Duty ratio=1%
Reverse voltage	V _R	5	V	
Power dissipation	P _D	150	mW	
Operating temperature	T _{opr}	-30 to +85		Avoid dew condensation
Storage temperature	T _{stg}	-30 to +100		Avoid dew condensation
Soldering temperature	T _{sol}	260		Soldering time less than 5 seconds

● Electrical and Optical characteristics

Parameter	Symbol	Value			Unit	Conditions
		Min.	Typ.	Max		
Forward voltage	V _F		1.5	1.8	V	I _F =50mA
Reverse Current	I _R			10	μA	V _R =5V
Optical output power	P _O		22		mW	I _F =50mA
Peak wavelength	λ		850		nm	I _F =50mA
Spectral width			40		nm	I _F =50mA
Half angle	2		30		deg	I _F =50mA
Rise time	t _r		25		ns	I _F =50mA
Fall time	t _f		15		ns	I _F =50mA

